

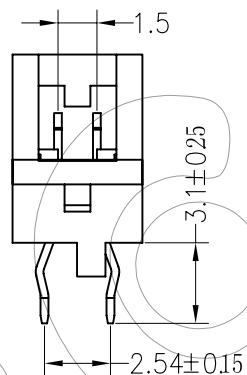
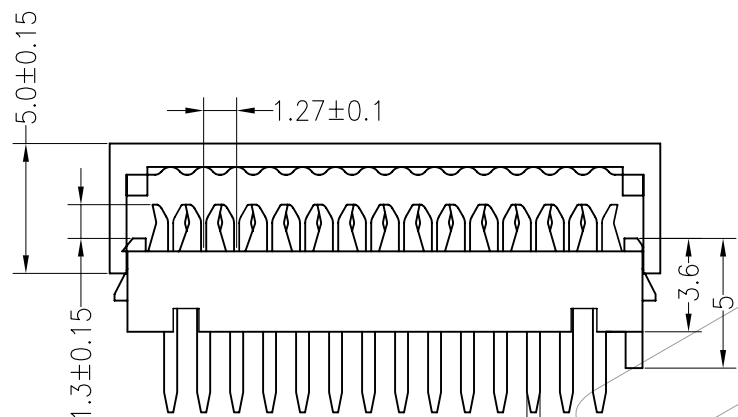
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PBT
Max.Processing Temp: 180°C for 30-60 seconds
(200°C for 5 seconds)



PINS	A	B
4	8.45	2.54
6	10.99	5.08
8	13.53	7.62
10	16.07	10.16
12	18.61	12.70
14	21.15	15.24
16	23.69	17.78
18	26.23	20.32
20	28.77	22.86
22	31.31	25.40
24	33.85	27.94
26	36.39	30.48

Ordering Information

HC-MH XX M I SN X N T 04

No.of
Pins
04~26P

Insulator Material
A=PBT
E=PA46

Packing
T=Tube

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^\circ$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-MHXXMISNXNT04

TITLE:

Micro Match DIP Male IDC Type

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9